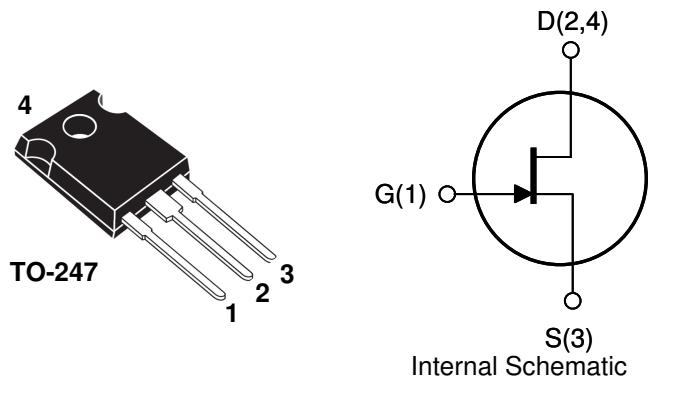


Normally-OFF Trench Silicon Carbide Power JFET

Features:

- Compatible with Standard Gate Driver ICs
- Positive Temperature Coefficient for Ease of Paralleling
- Temperature Independent Switching Behavior
- 175 °C Maximum Operating Temperature
- $R_{DS(on)max}$ of 0.550 Ω
- Voltage Controlled
- Low Gate Charge
- Low Intrinsic Capacitance

Product Summary		
BV_{DS}	1700	V
$R_{DS(ON)max}$	0.550	Ω
$E_{TS,typ}$	74	μJ



Applications:

- Flyback Auxillary Power Supplies for:
 - Solar inverters
 - Motor Drives
 - High Voltage SMPS
 - High Voltage UPS

MAXIMUM RATINGS

Parameter	Symbol	Conditions	Value	Unit
Continuous Drain Current	$I_{D, T_j=125}$	$T_j = 125 \text{ }^\circ\text{C}$	4	A
	$I_{D, T_j=175}$	$T_j = 175 \text{ }^\circ\text{C}$	3	
Pulsed Drain Current ⁽¹⁾	I_{DM}	$T_C = 25 \text{ }^\circ\text{C}$	8	A
Short Circuit Withstand Time	t_{SC}	$V_{DD} < 800 \text{ V}, T_C < 125 \text{ }^\circ\text{C}$	TBD	μs
Power Dissipation	P_D	$T_C = 25 \text{ }^\circ\text{C}$	58	W
Gate-Source Voltage	V_{GS}	AC ⁽²⁾	-15 to +15	V
Operating and Storage Temperature	$T_j, T_{j,stg}$		-55 to +175	°C
Lead Temperature for Soldering	T_{sold}	1/8" from case < 10 s	260	°C

⁽¹⁾ Limited by pulse width

⁽²⁾ $R_{GEXT} = 1 \text{ ohm}, t_o \leq 200\text{ns}$, see Figure 5 for static conditions

THERMAL CHARACTERISTICS

Parameter	Symbol	Value		Unit
		Typ	Max	
Thermal Resistance, junction-to-case	$R_{th,JC}$	-	2.6	°C / W
	$R_{th,JA}$	-	50	

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	

Off Characteristics

Drain-Source Blocking Voltage	BV _{DS}	V _{GS} = 0 V, I _D = 200 μA	1700	-	-	V
Total Drain Leakage Current	I _{DSS}	V _{DS} = 1700 V, V _{GS} = 0 V, T _j = 25°C	-	10	200	μA
		V _{DS} = 1700 V, V _{GS} = 0 V, T _j = 175°C	-	50	-	
		V _{DS} = 1700 V, V _{GS} ≤ -15 V, T _j = 25°C	-	10	-	
		V _{DS} = 1700 V, V _{GS} ≤ -15 V, T _j = 175°C	-	30	-	
Total Gate Reverse Leakage	I _{GSS}	V _{GS} = -15 V, V _{DS} = 0V	-	-0.02	-0.1	mA
		V _{GS} = -15 V, V _{DS} = 1700V	-	-0.02	-	

On Characteristics

Drain-Source On-resistance	R _{DS(on)}	I _D = 3 A, V _{GS} = 3 V, T _j = 25 °C	-	0.45	0.55	Ω
		I _D = 3 A, V _{GS} = 3 V, T _j = 125 °C	-	1.08	-	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = 1 V, I _D = 10 mA	0.75	1.00	1.25	V
Gate Forward Current	I _{GFWD}	V _{GS} = 3 V	-	135	-	mA
Gate Resistance	R _G	f = 1 MHz, drain-source shorted	-	15	-	Ω
	R _{G(ON)}	V _{GS} > 2.7V; See Figure 5	-	1	-	Ω

Dynamic Characteristics

Input Capacitance	C _{iss}	V _{DD} = 300 V	-	170	-	pF
Output Capacitance	C _{oss}		-	20	-	
Reverse Transfer Capacitance	C _{rss}		-	17	-	
Effective Output Capacitance, energy related	C _{o(er)}	V _{DS} = 0 V to 600 V, V _{GS} = 0 V	-	20	-	

Switching Characteristics

Turn-on Delay	t _{on}	V _{DS} = 850 V, I _D = 3 A, Inductive Load, T _j = 25°C Gate Driver = +15V unipolar R _{gEXT} = 20ohm	-	12	-	ns
Rise Time	t _r		-	14	-	
Turn-off Delay	t _{off}		-	28	-	
Fall Time	t _f		-	30	-	
Turn-on Energy	E _{on}		-	41	-	
Turn-off Energy	E _{off}	See Figure 14 and application note for gate drive recommendations	-	33	-	μJ
Total Switching Energy	E _{ts}		-	74	-	
Turn-on Delay	t _{on}		-	TBD	-	
Rise Time	t _r		-	TBD	-	
Turn-off Delay	t _{off}		-	TBD	-	
Fall Time	t _f	See Figure 14 and application note for gate drive recommendations	-	TBD	-	ns
Turn-on Energy	E _{on}		-	TBD	-	
Turn-off Energy	E _{off}		-	TBD	-	
Total Switching Energy	E _{ts}		-	TBD	-	
Total Gate Charge	Q _g		-	10	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} = 850 V, I _D = 3 A, V _{GS} = + 2.5 V	-	8	-	
Gate-Drain Charge	Q _{gd}		-	1	-	

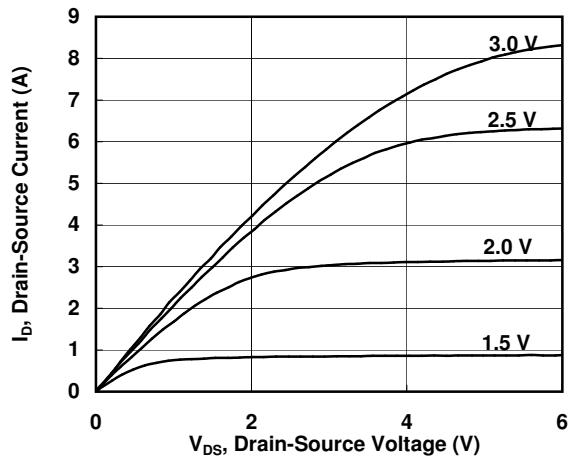
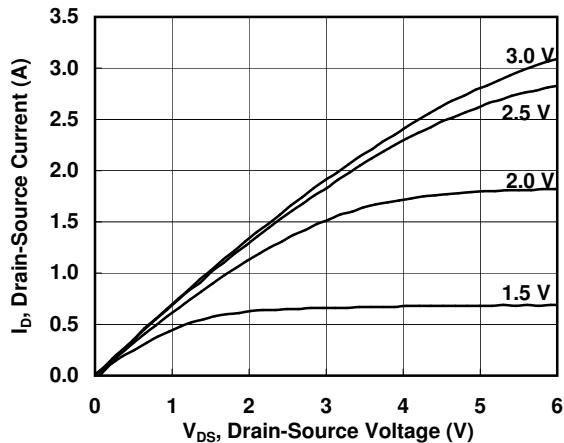
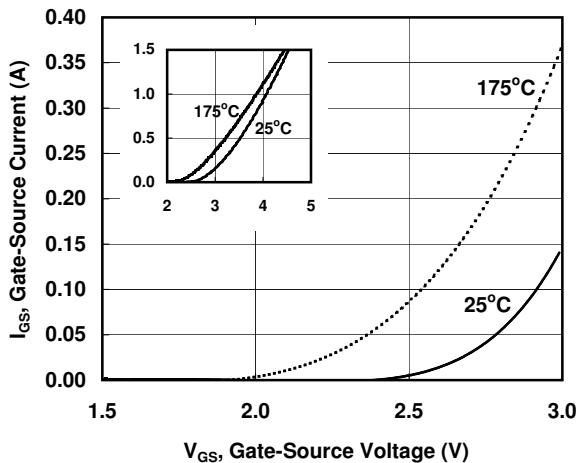
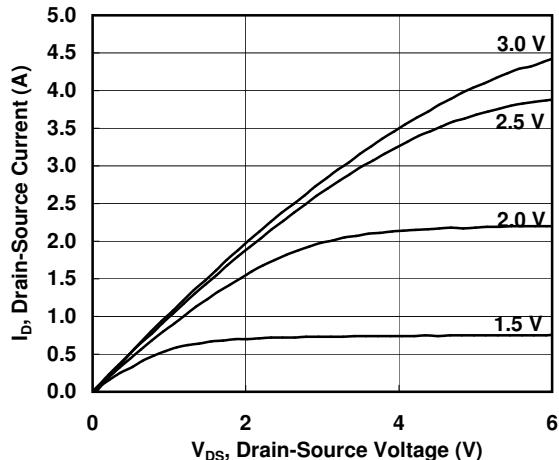
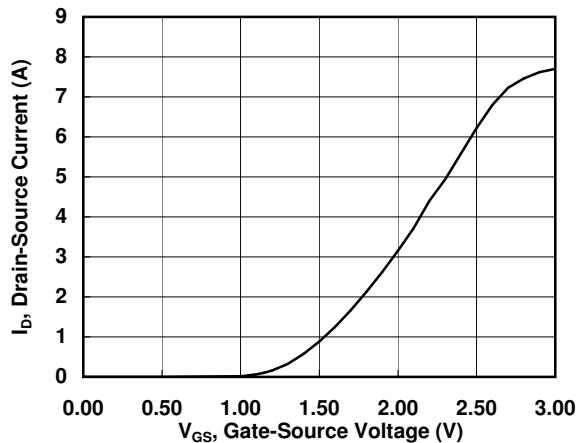
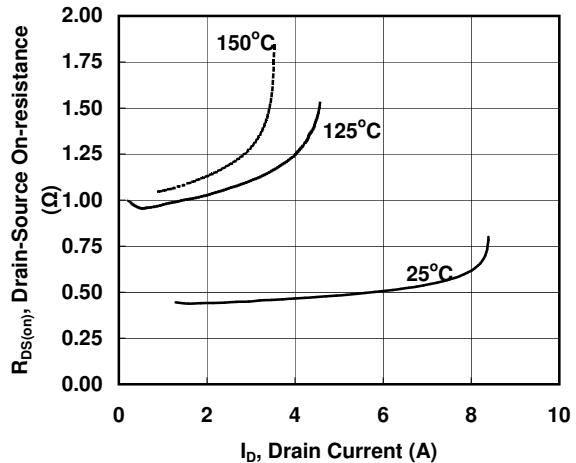
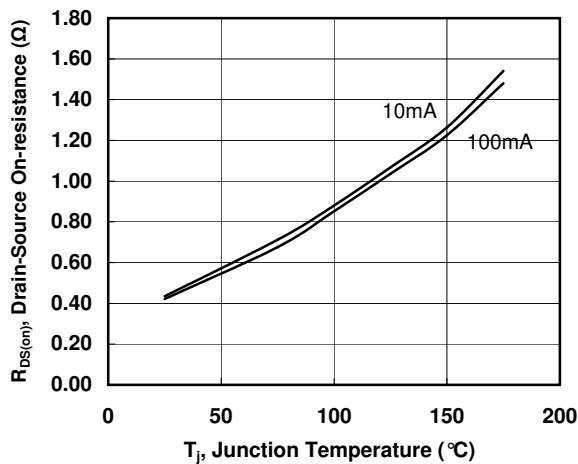
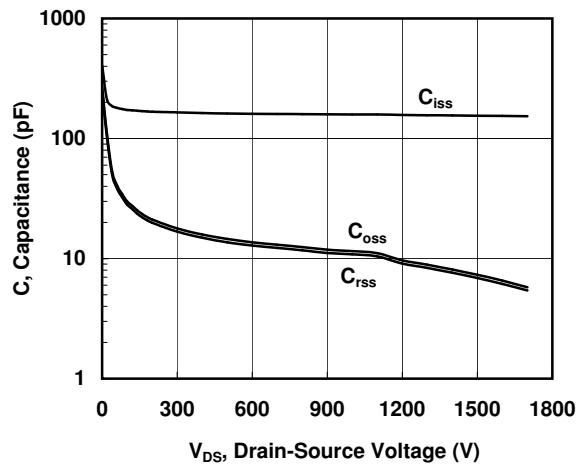
Figure 1. Typical Output Characteristics
 $I_D = f(V_{DS})$; $T_j = 25^\circ\text{C}$; parameter: V_{GS}

Figure 3. Typical Output Characteristics
 $I_D = f(V_{DS})$; $T_j = 175^\circ\text{C}$; parameter: V_{GS}

Figure 5. Gate-Source Current
 $I_{GS} = f(V_{GS})$; parameter: T_j

Figure 2. Typical Output Characteristics
 $I_D = f(V_{DS})$; $T_j = 125^\circ\text{C}$; parameter: V_{GS}

Figure 4. Typical Transfer Characteristics
 $I_D = f(V_{GS})$; $V_{DS} = 5\text{ V}$

Figure 6. Drain-Source On-resistance
 $R_{DS(on)} = f(I_D)$; $V_{GS} = 3.0\text{ V}$; parameter: T_j


Figure 7. Drain-Source On-resistance

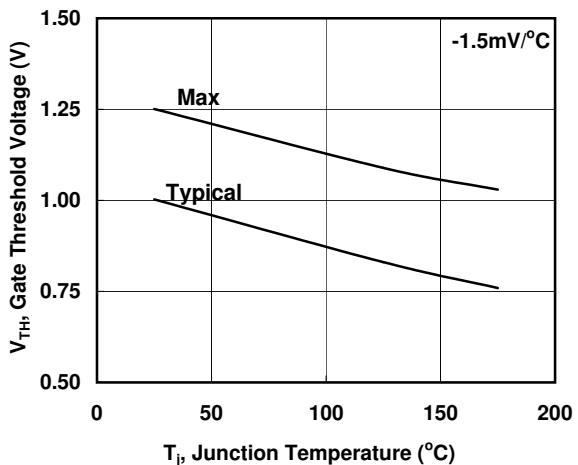
$$R_{DS(ON)} = f(T_j); \text{ parameter: } I_{GS}$$


Figure 9. Typical Capacitance

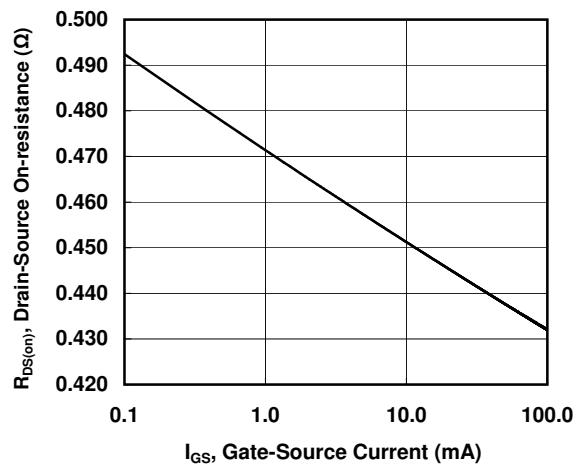
$$C = f(V_{DS}); V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$$


Figure 11. Gate Threshold Voltage

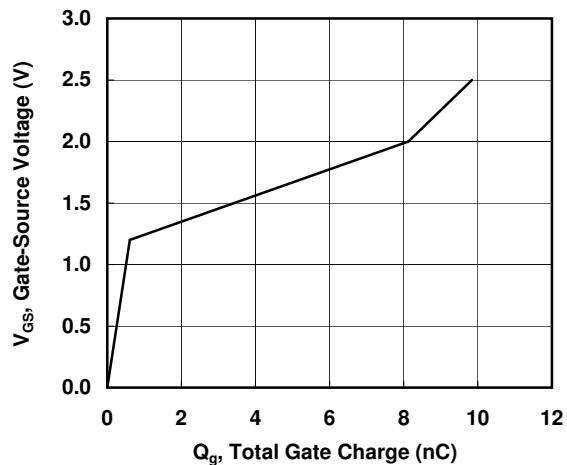
$$V_{th} = f(T_j), \text{ normalized}$$


Figure 8. Drain-Source On-resistance

$$R_{DS(ON)} = f(I_{GS}); T_j = 25^\circ\text{C}$$


Figure 10. Gate Charge

$$Q_g = f(V_{GS}); V_{DS} = 900 \text{ V}; I_D = 3 \text{ A}, T_j = 25^\circ\text{C}$$


Figure 12. Drain-Source Leakage

$$I_D = f(V_{DS}); V_{GS} = 0 \text{ V}; \text{ parameter: } T_j$$

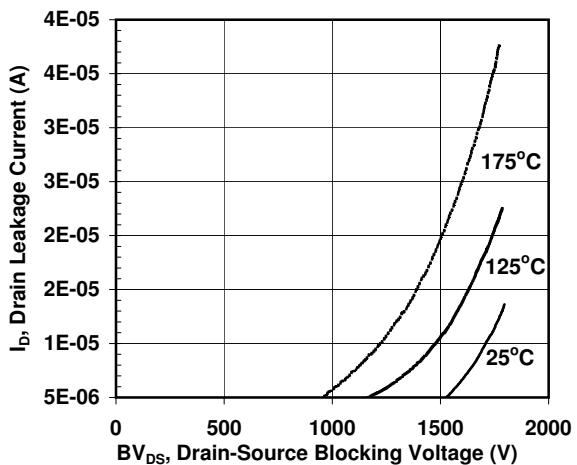
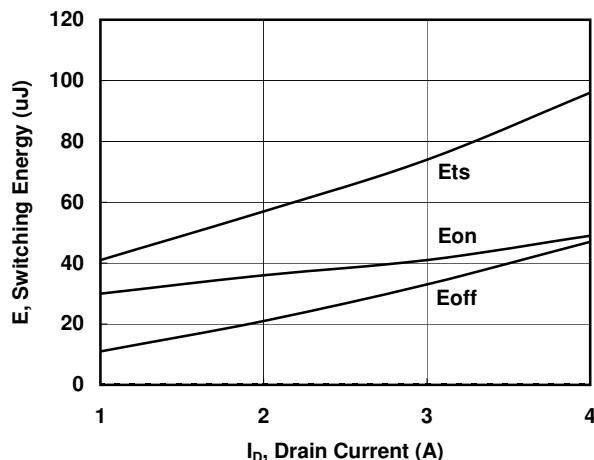
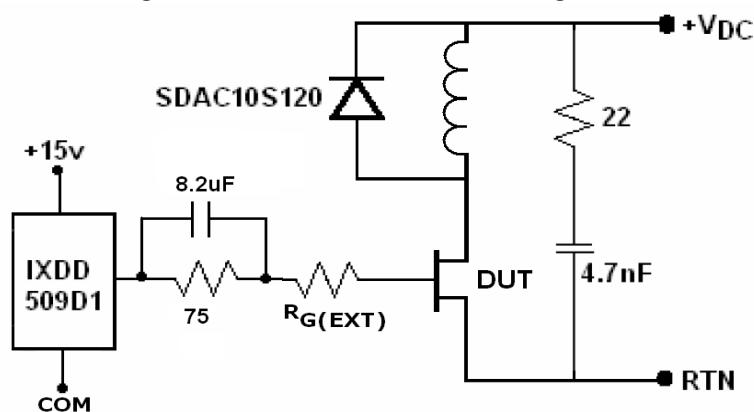
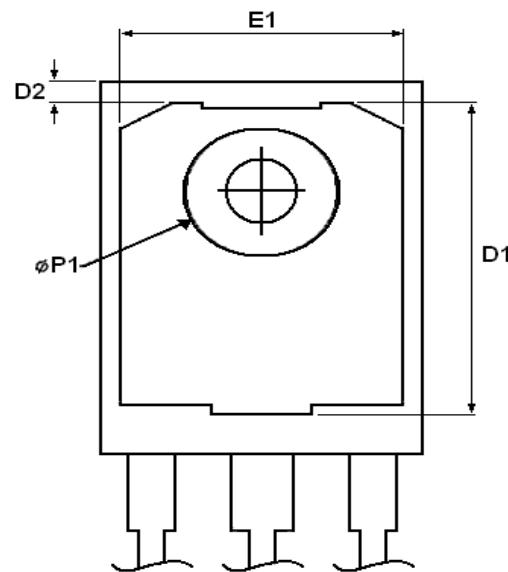
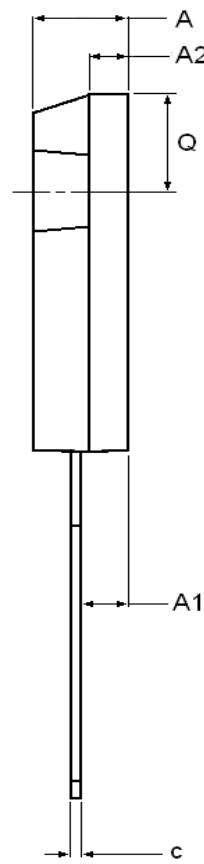
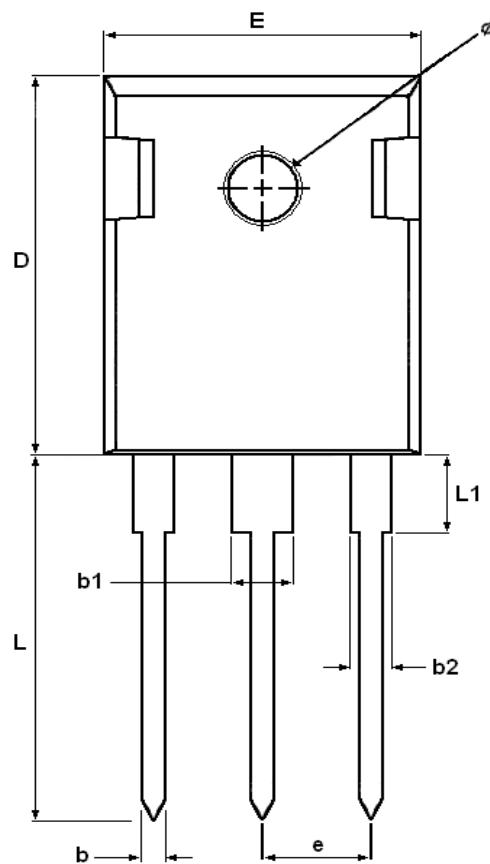


Figure 13. Switching Energy Losses
 $E_s = f(I_D)$; $V_{DS} = 850V$; $GD = +15V$, $R_{GEXT} = 20\text{ohm}$; $T_c = 25^\circ\text{C}$

Figure 14. Inductive Load Switching Circuit




DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.903	5.157	0.193	0.203
A1	2.273	2.527	0.090	0.100
A2	1.853	2.108	0.073	0.083
b	1.073	1.327	0.042	0.052
b1	2.873	3.381	0.113	0.133
b2	1.903	2.386	0.042	0.052
c	0.600	0.752	0.024	0.029
D	20.823	21.077	0.820	0.830
D1	17.393	17.647	0.685	0.695
D2	1.063	1.317	0.042	0.052
e	5.450		0.215	
E	15.773	16.027	0.621	0.631
E1	13.893	14.147	0.547	0.557
L	20.053	20.307	0.789	0.799
L1	4.168	4.472	0.165	0.175
Q	6.043	6.297	0.238	0.248
ØP	3.560	3.660	0.140	0.144
ØP1	7.063	7.317	0.278	0.288

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